

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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## MG06150S-BN4MM





#### **Features**

- High short circuit capability, self limiting short circuit current
- V<sub>CE(sat)</sub> with positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Low switching losses

#### **Agency Approvals**

AGENCY	AGENCY FILE NUMBER
<b>71</b>	E71639

### **Applications**

- High frequency switching application
- Medical applications
- Motion/servo control
- UPS systems

#### Module Characteristics (T<sub>c</sub> = 25°C, unless otherwise specified)

Symbol	Parameters	Test Conditions	Min	Тур	Max	Unit
T <sub>J</sub> max	Max. Junction Temperature				175	°C
T <sub>J op</sub>	Operating Temperature		-40		150	°C
T <sub>stg</sub>	Storage Temperature		-40		125	°C
V <sub>isol</sub>	Insulation Test Voltage	AC, t=1min		3000		V
CTI	Comparative Tracking Index		350			
Torque	Module-to-Sink	Recommended (M6)	3		5	N⋅m
Torque	Module Electrodes	Recommended (M5)	2.5		5	N⋅m
Weight				160		g

### Absolute Maximum Ratings (T<sub>c</sub> = 25°C, unless otherwise specified)

Symbol	Parameters	Test Conditions	Values	Unit
IGBT				
V <sub>CES</sub>	Collector - Emitter Voltage	T <sub>J</sub> =25°C	600	V
$V_{\text{GES}}$	Gate - Emitter Voltage		±20	V
1	DC Collector Current	T <sub>C</sub> =25°C	225	А
'c		T <sub>C</sub> =60°C	150	А
I <sub>CM</sub>	Repetitive Peak Collector Current	t <sub>p</sub> =1ms	300	А
P <sub>tot</sub>	Power Dissipation Per IGBT		500	W
Diode				
V <sub>RRM</sub>	Repetitive Reverse Voltage	T <sub>J</sub> =25°C	600	V
	Average Forward Current	T <sub>C</sub> =25°C	225	А
F(AV)		T <sub>c</sub> =60°C	150	А
I <sub>FRM</sub>	Repetitive Peak Forward Current	t <sub>p</sub> =1ms	300	А
l <sup>2</sup> t		$T_{J} = 125^{\circ}C$ , t=10ms, $V_{R} = 0V$	2000	A <sup>2</sup> s

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Life Support Note:

#### Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

# Electrical and Thermal Specifications (T<sub>c</sub> = 25°C, unless otherwise specified)

Symbol	Parameters	Test Conditions		Min	Тур	Max	Unit
IGBT		•		•	,		
V <sub>GE(th)</sub>	Gate - Emitter Threshold Voltage	$V_{CE} = V_{GE}$ , $I_C = 2.4 \text{mA}$		4.9	5.8	6.5	V
	Collector - Emitter	I <sub>C</sub> =150A, V <sub>GF</sub> =15V, T <sub>J</sub> =25°C			1.45		V
$V_{\text{CE(sat)}}$	Saturation Voltage	I <sub>c</sub> =150A, V <sub>GE</sub> =	:15V, T <sub>J</sub> =125°C		1.6		V
	Callacter Laglage Current	V <sub>CE</sub> =600V, V <sub>GI</sub>	=0V, T <sub>J</sub> =25°C			1	mA
CES	Collector Leakage Current	V <sub>CE</sub> =600V, V <sub>GE</sub>	=0V, T <sub>J</sub> =125°C			5	mA
I <sub>GES</sub>	Gate Leakage Current	$V_{CE}=0V,V_{GE}=\pm$	:15V, T <sub>J</sub> =125°C	-400		400	nA
R <sub>Gint</sub>	Integrated Gate Resistor				2		Ω
Q <sub>ge</sub>	Gate Charge	V <sub>cc</sub> =300V, I <sub>c</sub> =1	50A , V <sub>GE</sub> =±15V		1.6		μC
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> =25V, V <sub>GE</sub> =0V, f =1MHz			9.3		nF
C <sub>res</sub>	Reverse Transfer Capacitance				0.29		nF
	Turn on Dolov Times		T <sub>J</sub> =25°C		150		ns
t <sub>d(on)</sub>	Turn - on Delay Time		T <sub>J</sub> =125°C		160		ns
+	Rise Time	V <sub>cc</sub> =300V	T <sub>J</sub> =25°C		30		ns
t <sub>r</sub>			T <sub>J</sub> =125°C		40		ns
t	Turn - off Delay Time	I <sub>c</sub> =150A	T <sub>J</sub> =25°C		340		ns
t <sub>d(off)</sub>		$R_{G} = 3.3\Omega$	T <sub>J</sub> =125°C		370		ns
t,	Fall Time	11 <sub>G</sub> =3.312	T <sub>J</sub> =25°C		60		ns
	T dil Tillio	V <sub>GE</sub> =±15V	T <sub>J</sub> =125°C		70		ns
E <sub>on</sub>	Turn - on Energy	Inductive Load	T <sub>J</sub> =25°C		0.85		mJ
_on	ram on Energy	Inductive Load	T <sub>J</sub> =125°C		1.35		mJ
E <sub>off</sub>	Turn - off Energy		T <sub>J</sub> =25°C		4.1		mJ
off	.a en Energy		T <sub>J</sub> =125°C		5.3		mJ
I <sub>sc</sub>	Short Circuit Current	$t_{psc} \le 6\mu S$ , $V_{GE} = 15V$ ; $T_J = 125^{\circ}C$ , $V_{CC} = 360V$			750		А
R <sub>thJC</sub>	Junction-to-Case Thermal Resi	istance (Per IGBT)				0.3	K/VV
Diode							
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> =150A , V <sub>GE</sub>	=0V, T <sub>J</sub> =25°C		1.55		V
v <sub>F</sub>	Torvvaru vortage	I <sub>F</sub> =150A , V <sub>GE</sub> =	=0V, T <sub>J</sub> =125°C		1.5		V
I <sub>RRM</sub>	Max. Reverse Recovery Current	$I_{F}=150A$ , $V_{R}=300V$ $di_{F}/dt=-5400A/\mu s$ $T_{J}=125^{\circ}C$			180		А
O <sub>rr</sub>	Reverse Recovery Charge				13		μC
E <sub>rec</sub>	Reverse Recovery Energy				3.5		mJ
R <sub>thJCD</sub>	Junction-to-Case Thermal Resis	stance (Per Diode)				0.5	K/W



**Figure 1: Typical Output Characteristics** 

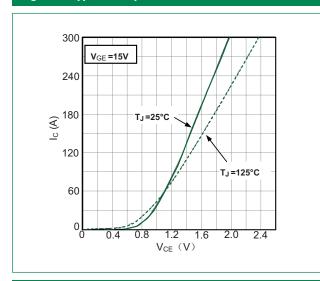


Figure 3: Typical Transfer characteristics

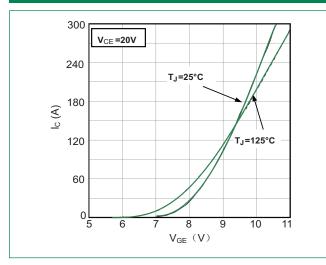


Figure 5: Switching Energy vs. Collector Current

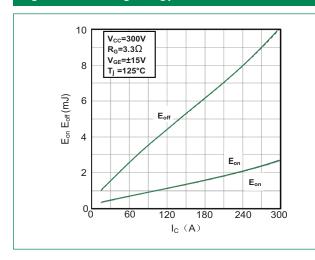


Figure 2: Typical Output characteristics

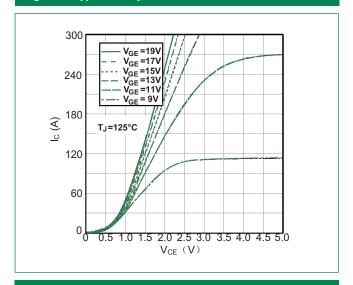


Figure 4: Switching Energy vs. Gate Resistor

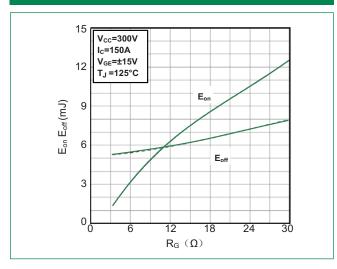


Figure 6: Reverse Biased Safe Operating Area

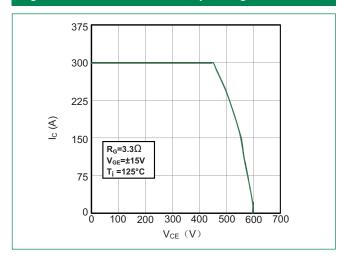


Figure 7: Diode Forward Characteristics

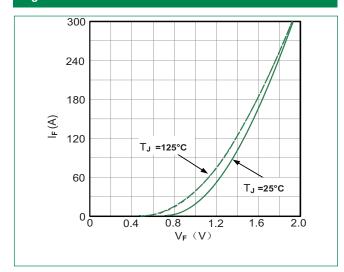


Figure 8: Switching Energy vs. Gate Resistor

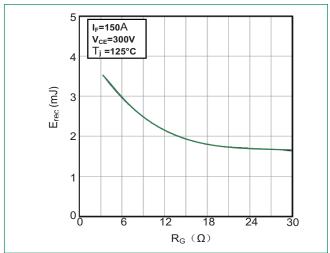


Figure 9: Switching Energy vs. Forward Current

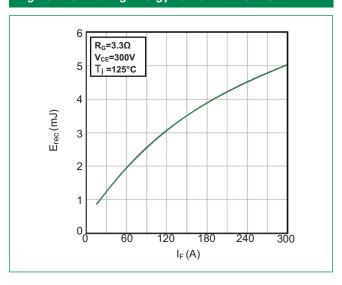
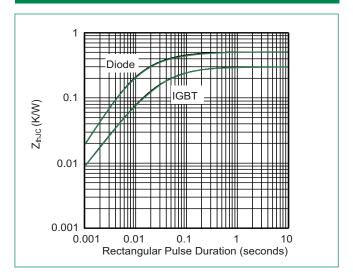
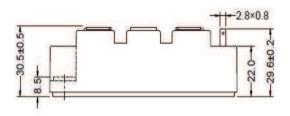
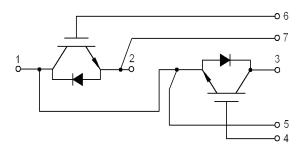


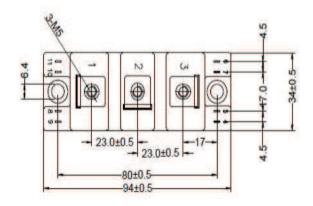
Figure 10: Transient Thermal Impedance



#### **Dimensions-Package S**



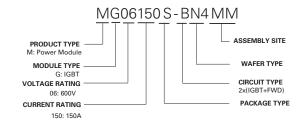




### **Packing Options**

Part Number	Marking	Weight	Packing Mode	M.O.Q
MG06150S-BN4MM	MG06150S-BN4MM	160g	Bulk Pack	100

### **Part Numbering System**



### **Part Marking System**

**Circuit Diagram** 

